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October 2014

FDMS86102LZ

N-Channel Shielded Gate PowerTrench[®] MOSFET 100 V, 22 A, 25 m Ω

100 V, 22 A, A

- Features
- Shielded Gate MOSFET Technology
- Max $r_{DS(on)} = 25 \text{ m}\Omega$ at $V_{GS} = 10 \text{ V}$, $I_D = 7 \text{ A}$
- Max $r_{DS(on)}$ = 37 m Ω at V_{GS} = 4.5 V, I_D = 5.8 A
- HBM ESD protection level > 6 KV typical (Note 4)
- 100% UIL Tested
- RoHS Compliant

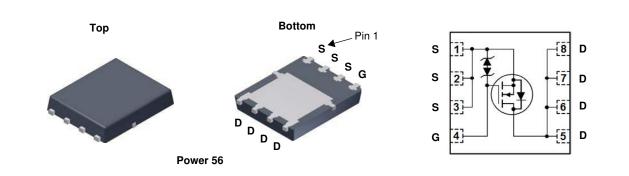


General Description

This N-Channel logic Level MOSFETs are produced using Fairchild Semiconductor's advanced PowerTrench[®] process that incorporates Shielded Gate technology. This process has been optimized for the on-state resistance and yet maintain superior switching performance. G-S zener has been added to enhance ESD voltage level.

Applications

- DC DC Conversion
- Inverter
- Synchronous Rectifier



MOSFET Maximum Ratings TA = 25 °C unless otherwise noted

Symbol	Param	eter		Ratings	Units	
V _{DS}	Drain to Source Voltage			100	V	
V _{GS}	Gate to Source Voltage			±20	V	
	Drain Current -Continuous	T _C = 25 °C		22		
I _D	-Continuous	T _A = 25 °C	(Note 1a)	7	А	
	-Pulsed			40		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	84	mJ	
P _D	Power Dissipation	T _C = 25 °C		69		
	Power Dissipation	T _A = 25 °C	(Note 1a)	2.5		
T _J , T _{STG}	Operating and Storage Junction Tempera	ature Range		-55 to +150	°C	

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	1.8	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1a) 50	C/ VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86102Z	FDMS86102LZ	Power 56	13 "	12 mm	3000 units

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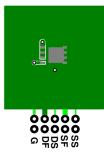
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	100			V
ΔBV_{DSS} ΔT_J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to 25 °C		70		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 80 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±10	μA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	1.0	1.5	2.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-6		mV/°C
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 7 \text{ A}$		18.6	25	
r _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 4.5 \text{ V}, \ I_D = 5.8 \text{ A}$		23.5	37	mΩ
		$V_{GS} = 10 \text{ V}, \ I_D = 7 \text{ A}, \ T_J = 125 \text{ °C}$		31.2	42	
9 _{FS}	Forward Transconductance	$V_{DS} = 5 V, I_D = 7 A$		26		S
	Characteristics			070	4005	
C _{iss}	Input Capacitance	V _{DS} = 50 V, V _{GS} = 0 V,		979	1305	pF
C _{oss}	Output Capacitance	-f = 1 MHz		175	235	pF
C _{rss}	Reverse Transfer Capacitance Gate Resistance			8.9 0.9	15	pF
R _g	Gale Resistance			0.9		Ω
Switching	g Characteristics					
t _{d(on)}	Turn-On Delay Time			6.7	14	ns
t _r	Rise Time	$V_{DD} = 50 \text{ V}, \text{ I}_{D} = 7 \text{ A},$		2.6	10	ns
t _{d(off)}	Turn-Off Delay Time	V_{GS} = 10 V, R_{GEN} = 6 Ω		19	35	ns
t _f	Fall Time			2.5	10	ns
Q _{g(TOT)}	Total Gate Charge	$V_{GS} = 0$ V to 10 V		16	22	nC
Q _{g(TOT)}	Total Gate Charge	$ \begin{array}{c} V_{GS} = 0 \ V \ to \ 10 \ V \\ V_{GS} = 0 \ V \ to \ 4.5 \ V \\ I_D = 50 \ V, \\ I_D = 7 \ A \end{array} $		7.8	11	nC
Q _{gs}	Total Gate Charge	$I_D = 7 \text{ A}$		2.4		nC
Q _{gd}	Gate to Drain "Miller" Charge			2.6		nC
*	uran Diado Charantoristica					
50l	urce Diode Characteristics	$V_{GS} = 0 V, I_S = 7 A$ (Note 2)		0.81	1.3	1
V _{SD}	Source to Drain Diode Forward Voltage	$\mathbf{v}_{GS} = \mathbf{v} \mathbf{v}, \mathbf{v}_{S} = \mathbf{r} \mathbf{r}$ (Note 2)		0.01	1.0	V

v	SD	

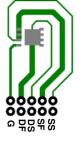
Source to Drain Diode Forward Voltage V V_{GS} = 0 V, I_S = 2 A (Note 2) 0.72 1.2 **Reverse Recovery Time** 35 57 ns t_{rr} $I_F = 7 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$ Q_{rr} Reverse Recovery Charge 25 40 nC

NOTES:

. R_{0.1} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0.JC} is guaranteed by design while R_{0CA} is determined by the user's board design.



a. 50 °C/W when mounted on a 1 in² pad of 2 oz copper



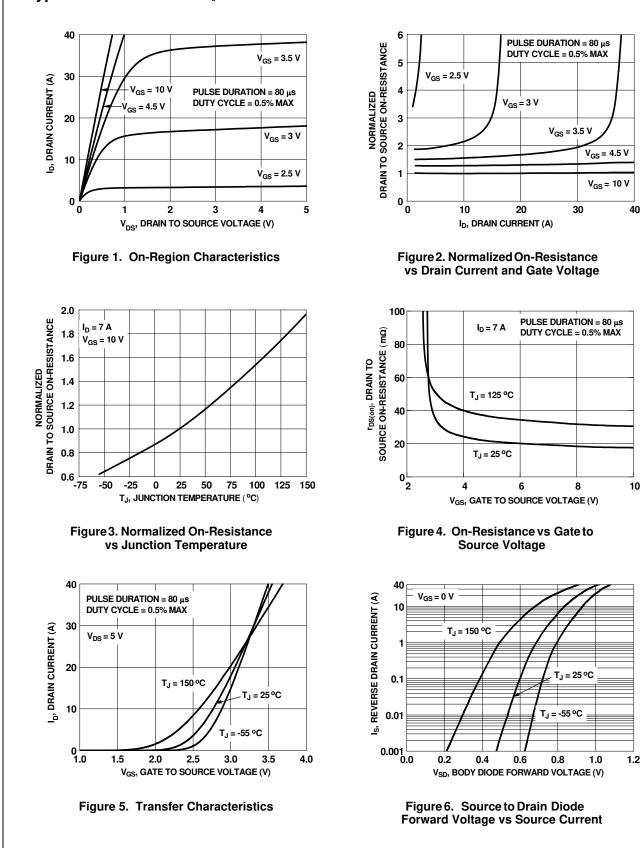
b. 125 °C/W when mounted on a minimum pad of 2 oz copper

2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%.

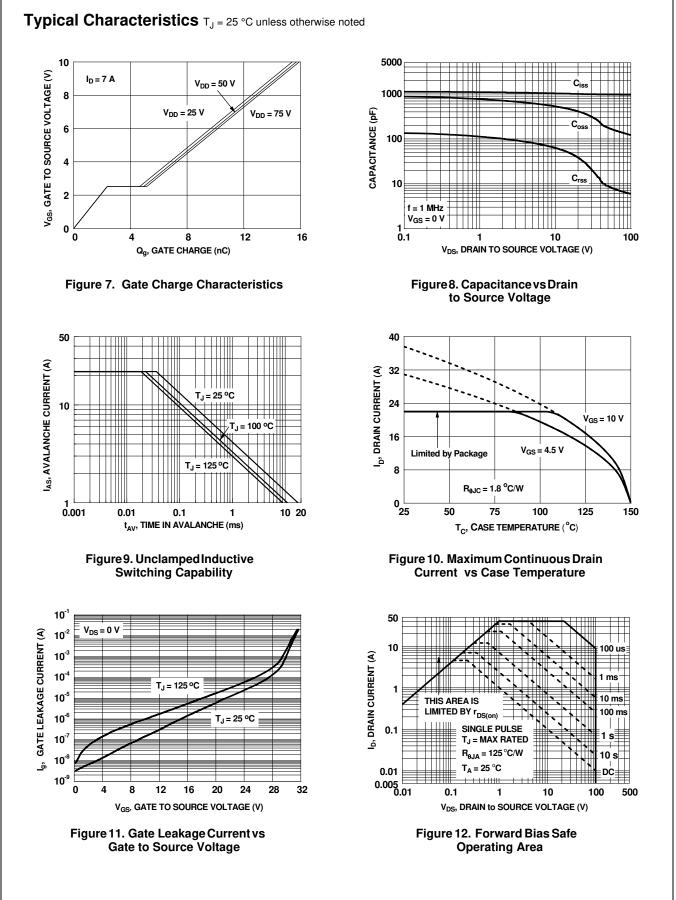
3. Starting T_J = 25 °C; N-ch: L = 1 mH, I_{AS} = 13 A, V_{DD} = 90 V, V_{GS} = 10 V.

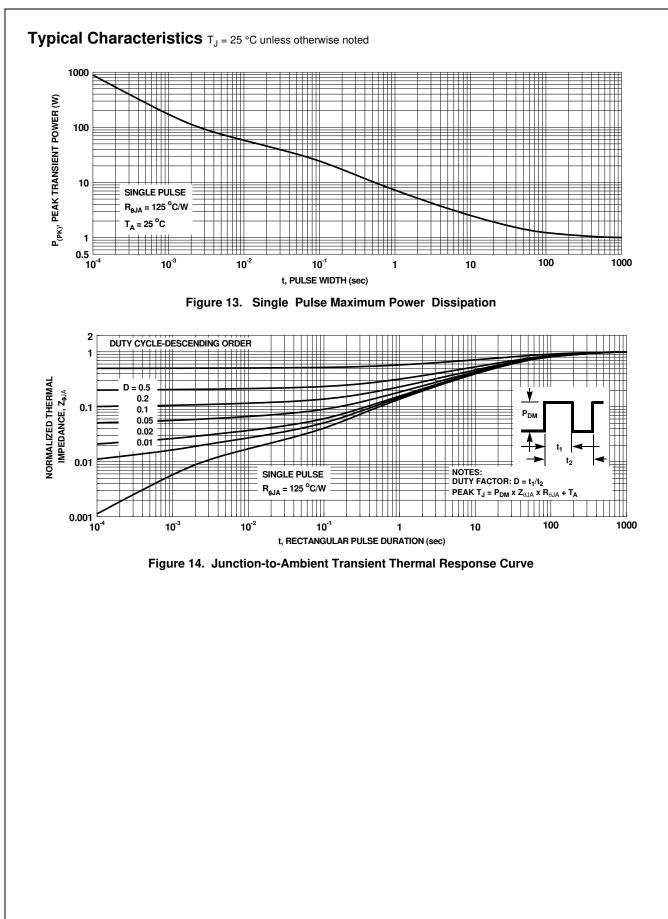
4. The diode connected between gate and source serves only as protection against ESD. No gate overvoltage rating is implied.



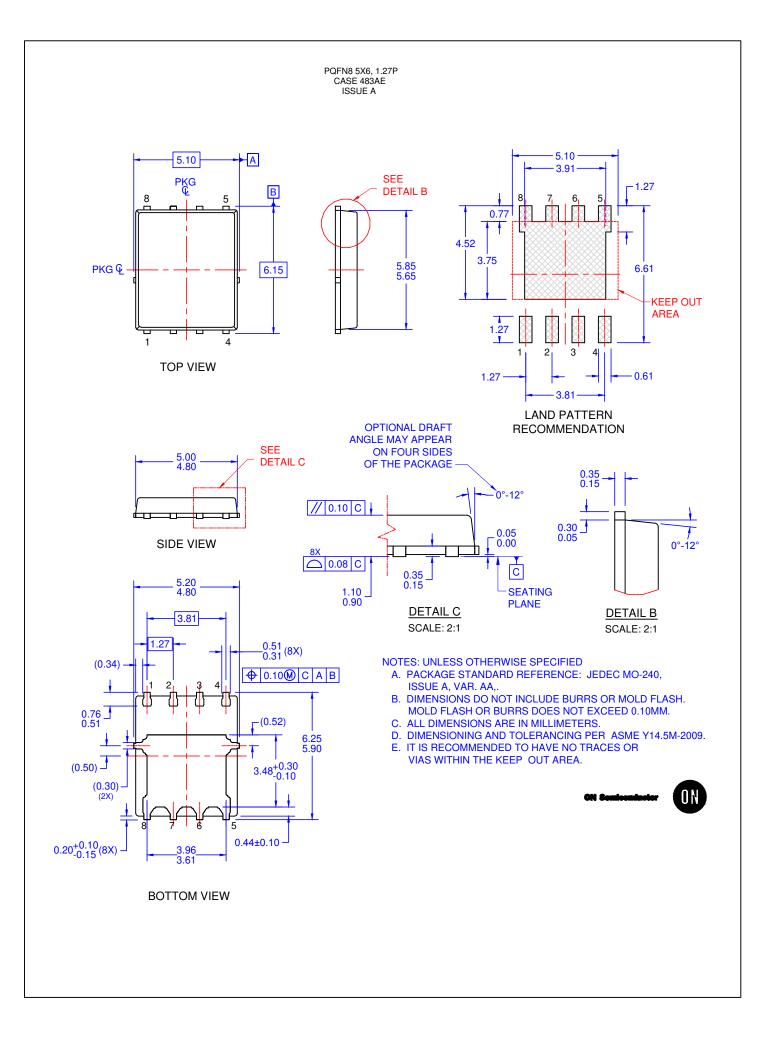


Typical Characteristics T_J = 25 °C unless otherwise noted





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